ABSOCIATION CONNECTING LECTRONICS INDUSTRIES INDUSTRIES INDUSTRIES	C. Bannockb	urn. Illinois. A	ll rights reserved un tions.	nder both	This docum level parts,	ent is a declaration en	n of the substan compasses all lo	ces within the manufacture ower level materials for w	rer listed i hich the n	tem. Note: if nanufacturer	the item is an as has engineering	ssembly with lower responsibility.	
				Form Type Distribute					ials and M	ls and Mfg Information			
Supplier Information													
Company name* Company			pany unique ID			Unique ID Authority				Response Date*			
onsemi										2025-05-11			
Contact Name Title - Contact			ntact			Phone - Contact*			Email - Contact*				
Product-Env-Stewards Product Envi			nviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			esentative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Env			Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	MMBFJ	MMBFJ176 SOT-		SOT-23 J176 MARKED 6X		2025-05-11		РВВ		8.706	mg	Each	
Manufacturing Proccess Informati	on							·					
Terminal Plating / Grid Array Mat	Material Terminal Base		Alloy J-STD-020 MSL Ratin		Rating	Peak Process Body Temperature Max Time		ature Max Time at Peak	ak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy		1			260	С	30	secon	ids 3				
Comments													
evel 1 - maximum time at peak temperatur	e during sol	dering is 10-3	0 seconds										
For more information regarding material c	omposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.048	mg	Supplier	Silicon (Si)	7440-21-3		0.048	mg
Lead Frame	2.371	mg	Supplier	Silver (Ag)	7440-22-4		0.0474	mg
			В	Nickel (Ni)	7440-02-0		0.8607	mg
			Supplier	Iron (Fe)	7439-89-6		1.1902	mg
			Supplier	Copper (Cu)	7440-50-8		0.2727	mg
Mold Compound-Black	6.061	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.0303	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		0.3031	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.6061	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0303	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.7882	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3031	mg
Plating	0.206	mg	Supplier	Tin (Sn)	7440-31-5		0.206	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg